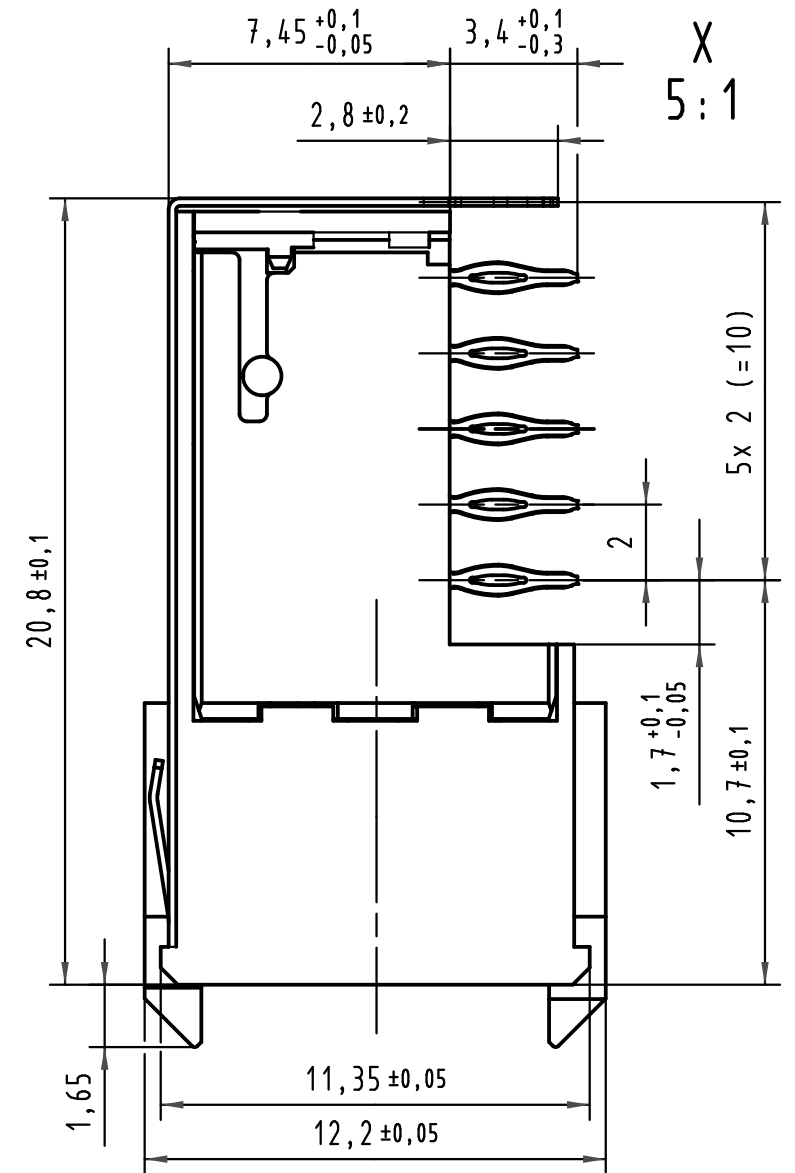
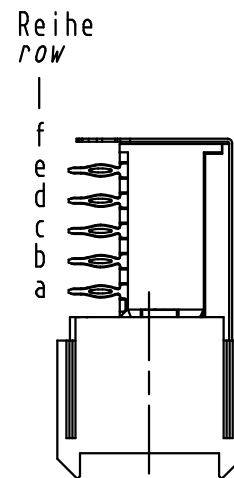
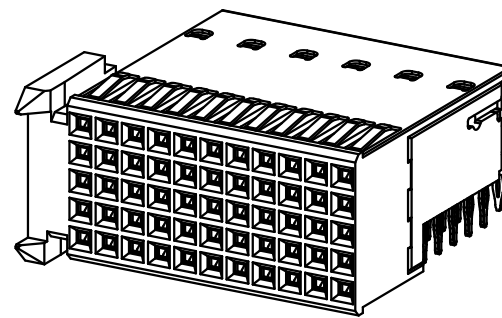
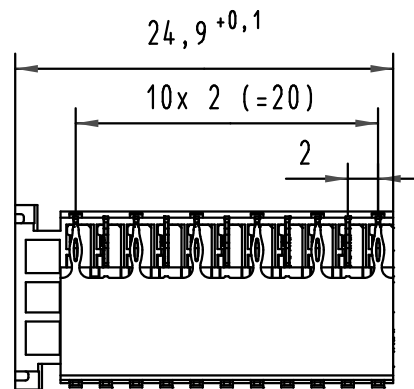
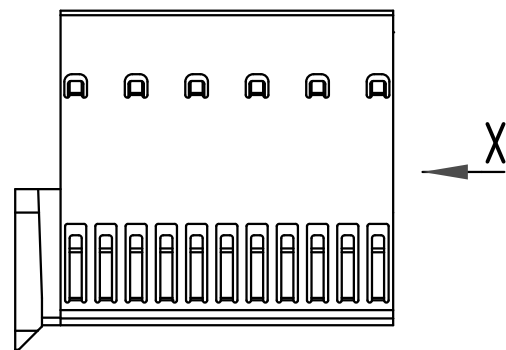
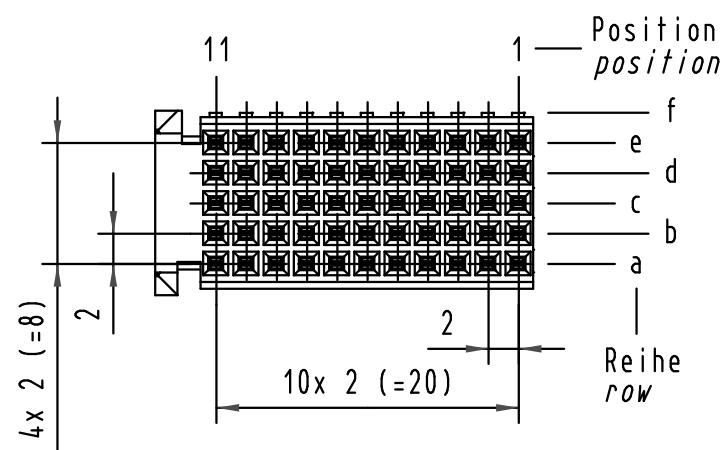
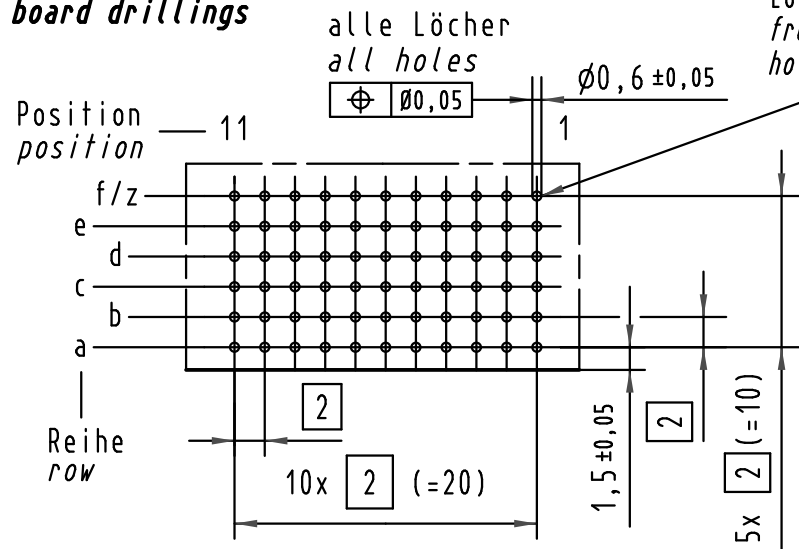




Lochbild board drillings



alle Löcher
all holes

$\phi 0,6 \pm 0,05$

Von f/z/1 aus, jedes 2.
Loch f. obere Abschirmung
from f/z/1, each 2nd
hole f. upper shielding

Bohrlochdurchmesser: $\phi 0,7 \pm 0,02$ mm
Lochdurchmesser (mit Oberfläche): $\phi 0,6 \pm 0,05$ mm
drill hole dia.: $\phi 0,7 \pm 0,02$ mm
through hole dia. (after plating): $\phi 0,6 \pm 0,05$ mm

17 23 055 <u>4</u> 102	—	min.0,76µm (30µin) Au über/over min.1,27µm (50µin) Ni
17 23 055 <u>2</u> 102	2	Au über/over Ni
17 23 055 <u>1</u> 102	1	Au über/over Ni
Bestell-Nr. part-no.	Anforderungsstufe nach IEC performance level acc. to IEC	Kontaktoberfläche contact plating

All Dimensions in mm Original Size DIN A 3			Techn. Character.			Nicht tolerierte Maße/Free size tolerances IEC 61076-4-101	
				Dat.	Name	2:1 (5:1)	har-bus HM Federleiste, Typ C, 55 pol. mit Schirmblech Reihe-f har-bus HM female connector, type C, 55 pol. with shield row-f
35456	01.12.08	TD	Detail.	29.06.99	Hm		
32387	18.11.04	HL.	Insp.	29.06.99	Ko		
29412	07.05.01	Lk	Stand.				
28494	20.09.00	Koe	HARTING Electronics GmbH & Co. KG D-32339 ESPELKAMP			TB 17 23 055 x102	Blatt/ page
25016							
Mod.	Dat.	Name				Sub.	